

**In the Claims:**

1. (Previously Presented) A semiconductor light emitting device comprising:  
a substrate having a face that includes a cavity therein;  
a flexible film that includes therein an optical element, wherein the flexible film extends onto, and is attached to, the face beyond the cavity and the optical element overlies the cavity;  
a semiconductor light emitting element in the cavity and configured to emit light through the optical element; and  
an optical coupling media in the cavity between the optical element and the semiconductor light emitting element.
2. (Canceled)
3. (Original) A device according to Claim 1 wherein the optical element comprises a lens.
4. (Original) A device according to Claim 1 wherein the optical element comprises a prism.
5. (Original) A device according to Claim 4 wherein the semiconductor light emitting element includes a wire that extends towards the flexible substrate and wherein the prism is configured to reduce shadowing by the wire, of the light that is emitted from the semiconductor light emitting element.
6. (Original) A device according to Claim 3 further comprising phosphor on the flexible film between the lens and the semiconductor light emitting element.
7. (Original) A device according to Claim 6 wherein the lens includes a concave inner surface adjacent the semiconductor light emitting element and wherein the phosphor comprises a conformal phosphor layer on the concave inner surface.
8. (Previously Presented) A device according to Claim 1 wherein at least a portion of the flexible film that overlies the cavity is transparent to the light and wherein at least a portion of the flexible film that extends onto the face beyond the cavity is opaque to the light.

9. (Previously Presented) A device according to Claim 1 wherein at least a portion of the flexible film that overlies the cavity comprises a first material and wherein at least a portion of the flexible film that extends onto the face beyond the cavity comprises a second material.

10. (Previously Presented) A device according to Claim 1 wherein the semiconductor light emitting element includes a wire that extends towards and contacts the flexible film in the cavity and wherein the flexible film includes a transparent conductor in the cavity that electrically connects to the wire.

11. (Previously Presented) A device according to Claim 1 wherein the optical element comprises a lens that overlies the cavity and protrudes away from the cavity, the flexible film further comprising a protruding element between the lens and the semiconductor light emitting element that protrudes towards the cavity.

12. (Original) A device according to Claim 11 further comprising a conformal phosphor layer on the protruding element.

13. (Original) A device according to Claim 1 wherein the flexible film includes a first face adjacent the substrate and a second face remote from the substrate and wherein the optical element comprises a first optical element on the first face and a second optical element on the second face, both of which are located such that the light emitting element emits light through the first optical element and the second optical element.

14. (Original) A device according to Claim 1 further comprising an attachment element that is configured to attach the flexible film and the substrate to one another.

15. (Previously Presented) A device according to Claim 1 wherein the cavity is a first cavity, wherein the optical element is a first optical element and wherein the semiconductor light emitting element is a first semiconductor light emitting element, the flexible film including therein a second optical element that is spaced apart from the first optical element, wherein the face includes a second cavity therein, wherein the flexible film extends onto and is attached to the

face beyond the first and second cavities, wherein the second optical element overlies the second cavity and wherein the second semiconductor light emitting element is in the second cavity, the device further comprising an optical coupling media in the second cavity between the second optical element and the second semiconductor light emitting element.

16. (Canceled)

17. (Previously Presented) A device according to Claim 15 further comprising a first phosphor layer on the flexible film between the first optical element and the first semiconductor light emitting element and a second phosphor layer on the flexible film between the second optical element and the second semiconductor light emitting element.

18. (Original) A device according to Claim 17 wherein the first and second phosphor layers comprise different phosphors.

19. (Previously Presented) A device according to Claim 47 wherein the optical element is a first optical element, the flexible film includes therein a second optical element that is spaced apart from the first optical element and wherein the first and second optical elements overlie the cavity.

20. (Original) A device according to Claim 19 further comprising a first phosphor layer on the flexible film between the first optical element and the first semiconductor light emitting element and a second phosphor layer on the flexible film between the second optical element and the second semiconductor light emitting element.

21. (Original) A device according to Claim 20 wherein the first and second phosphor layers comprise different phosphors.

22. (Original) A device according to Claim 1 wherein the semiconductor light emitting element comprises a light emitting diode.

23. (Previously Presented) A device according to Claim 15 wherein the flexible film includes therein a third optical element that is spaced apart from the first and second optical

elements, the face including a third cavity therein, the device further comprising a third semiconductor light emitting element in the third cavity and configured to emit light through the third optical element, the device further comprising an optical coupling media in the third cavity between the third optical element and the third semiconductor light emitting element.

24. (Original) A device according to Claim 23 further comprising a first phosphor layer on the flexible film between the first optical element and the first semiconductor light emitting element, a second phosphor layer on the flexible film between the second optical element and the second semiconductor light emitting element and a third phosphor layer on the flexible film between the third optical element and the third semiconductor light emitting element.

25. (Original) A device according to Claim 24 wherein the first phosphor layer and the first semiconductor light emitting element are configured to generate red light, the second phosphor layer and the second semiconductor light emitting element are configured to generate blue light and the third phosphor layer and the third semiconductor light emitting element are configured to generate green light.

26. (Original) A device according to Claim 1 wherein the optical element comprises phosphor.

27. (Original) A device according to Claim 26 wherein the optical element comprises a lens having phosphor dispersed therein.

28. (Original) A device according to Claim 1 wherein the optical element comprises an optical emission enhancing and/or converting element.

29. (Original) A device according to Claim 1 wherein the optical element comprises an optical scattering element.

30.-31. (Canceled)

32. (Previously Presented) A device according to Claim 6 wherein the optical coupling media is between the phosphor and the semiconductor light emitting element.

33. (Previously Presented) A device according to Claim 11 wherein the optical coupling media is between the protruding element and the semiconductor light emitting element.

34. (Previously Presented) A device according to Claim 12 wherein the optical coupling media is between the conformal phosphor layer and the semiconductor light emitting element.

35.-46. (Canceled)

47. (Previously Presented) A device according to Claim 1 wherein the semiconductor light emitting element is a first semiconductor light emitting element, wherein the face includes a cavity therein, wherein the flexible film extends onto, and is attached to, the face beyond the cavity and the optical element overlies the cavity, the device further comprising a second semiconductor light emitting element, wherein the first and second semiconductor light emitting elements are in the cavity, and wherein the optical media extends between the second semiconductor light emitting elements and the optical element.

48. (New) A semiconductor light emitting device comprising:  
a substrate comprising alumina;  
a light emitting diode on a face of the substrate; and  
a flexible film comprising silicone on the face of the substrate and on the light emitting diode, the flexible film comprising silicone including therein a lens comprising silicone adjacent the light emitting diode, such that the light emitting diode emits light through the lens.

49. (New) A semiconductor light emitting device according to Claim 48 wherein the flexible film comprising silicone is attached to the substrate such that the flexible film comprising silicone conforms to the light emitting diode as it expands and contracts during operation thereof.